

SPICE Device Model Si7230DN Vishay Siliconix

Tionay C

N-Channel 30-V (D-S) MOSFET

CHARACTERISTICS

- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS

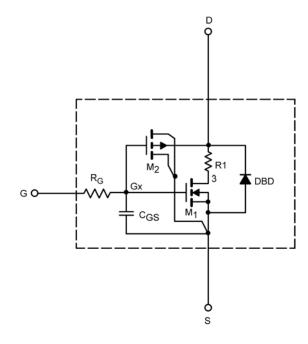
- Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to 125° C temperature ranges under the pulsed 0-V to 10-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched $C_{\rm gd}$ model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.

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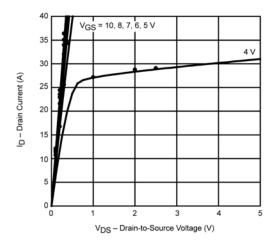
SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)					
Parameter	Symbol	Test Condition	Simulated Data	Measured Data	Unit
Static					
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.1		V
On-State Drain Current ^a	I _{D(on)}	$V_{DS}~\geq 5V,~V_{GS}$ = 10V	490		Α
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = 10V, I_D = 14A$	0.009	0.009	Ω
		$V_{GS} = 4.5V, I_D = 12A$	0.013	0.013	
Forward Transconductance ^a	g _{fs}	$V_{DS} = 15V, I_{D} = 14A$	31	32	
Forward Voltage ^a	V _{SD}	$I_S = 3.2A, V_{GS} = 0 V$	0.81	0.80	V
Dynamic ^b					
Total Gate Charge	Q_g	V _{DS} = 15V, V _{GS} = 5V, I _D = 14A	13.2	13.2	nC
Gate-Source Charge	Q_gs		5.3	5.3	
Gate-Drain Charge	Q_{gd}		4.3	4.3	

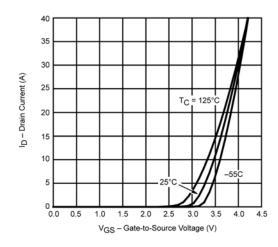
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2%. b. Guaranteed by design, not subject to production testing.

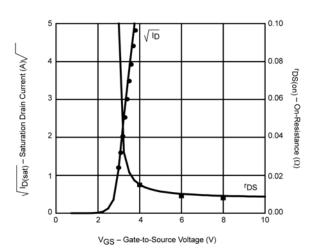


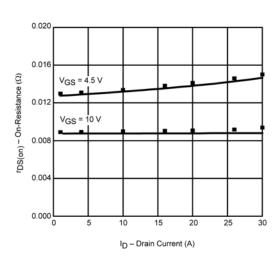
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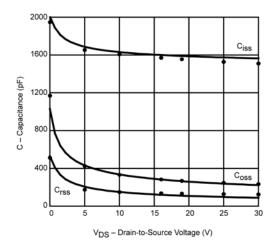
COMPARISON OF MODEL WITH MEASURED DATA (TJ=25°C UNLESS OTHERWISE NOTED)

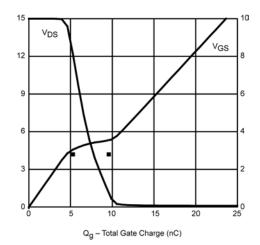












Note: Dots and squares represent measured data.



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